

# VCC-80A350H 808nm 350mW VCSEL Chip

#### Description

The Lasermate VCC-80A350H is an 808nm wavelength, 350mW output power, multi-emitter, Vertical Cavity Surface Emitting Laser (VCSEL) chip designed for use in 3D sensors, lidars, IR illumination, medical, solid-state pump source applications.

#### Features

- 808nm multi-emitter VCSEL chip
- Number of emitters: 39
- Power Conversion Efficiency (PCE): 26%
- Low threshold current
- Typical 350mW output power at 475mA
- Chip size: 294um x 278um
- Chip thickness: 100um

## **Specifications**

# Applications

- 3D sensors
- Lidars
- IR illuminations
- Medical application
- Solid-state pump source

Absolute Maximum Ratings								
Parameters	Symbol	Rating	Unit	Conditions				
Case Operating Temperature	Тор	-40 to 85	°C					
Storage Temperature	Tstg	-40 to 105	°C					
Reflow Soldering Temperature	Tsol	320	°C	10 seconds				
Reverse Voltage	Vr	5	V					
Maximum Continuous Current	Imax	750	mA					
ESD Exposure (Human Body) Model	ESD	2K	V					

Electro-Optical Characteristics (Top=25°C, Pulse width 0.1ms, duty cycle 1%)								
Parameters	Symbol	Min.	Тур.	Max.	Unit	Conditions		
Optical Output Power	Po	-	350	-	mW	I <sub>F</sub> =475mA		
Forward Current	lf	-	475	-	mA			
Threshold Current	Ith	-	60	-	mA			
Forward Voltage	VF	-	2.5	-	V	I <sub>F</sub> =475mA		
Power Conversion Efficiency	PCE	-	26	-	%	I <sub>F</sub> =475mA		
Slope Efficiency	η	-	1.09	-	mW/mA	P₀=350mW		
Peak Wavelength	λρ	800	808	816	nm	I <sub>F</sub> =475mA		
Series Resistance	Rs	-	1.74	-	Ohm	I⊧=475mA		
Wavelength Temperature Drift	Δλρ/ ΔΤ	-	0.07	-	nm/°C	I⊧=475mA		
Beam Divergence	FWHM <sub>B</sub>	-	25	-	deg			
Emission Area			231x210		um <sup>2</sup>			
Number of Emission Aperture		-	38	-				

Note: Electro-optical characteristic with a package or diffuser would require further evaluation. Values are based on limited sample size and estimated values.



#### **Typical Characteristics** LIV Graph **Typical Spectral Width** 500 15000 35 (counts) 400 808nm 25 300 5000 Intensity Po (mW) 20 0 750 800 850 900 950 000 ength (nm) 100 Po Vf PCE 100 200 400 500 300 If (mA) **Outline Diagram (unit: um)** 38 ape: 294um x 278um 278 um 0000 000000 000000 Bottom side: Cathode 000000 294 um Chip size: 294um x 278um Top side: Anode 000000 Chip thickness: 100um 0000 No. emission aperture: 38 0000 4 90 um

Chip thickness: 100um

## **Additional Notes**

- Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions above those indicated in the operations section for expanded periods of time may affect reliability.
- In its maximum rating diode laser operation could damage its performance or cause potential safety hazard such as equipment failure.
- Electrostatic discharge is the main reason for laser fault of the diode. Take effective precautions against ESD. When dealing with laser diodes, use wrist strap, grounding work surface and strict antistatic technology.
- The inherent design of this component causes it to be sensitive to electrostatic discharge (ESD). To prevent ESD-induced damage and/or degradation to equipment, take normal ESD precautions when handling this product.
- Specifications are subject to change without notice.